



Product Change Notification

Change Notification #: 118936-00
Change Title: Intel® Server System R2208WF0ZSR,
PCN 118936-00, Product Material,
Materials second source
Date of Publication: March 11, 2022

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	March 26, 2022
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the "Products Affected" table.

- Adding a second source for the Over Current Protection (OCP) Integrated Circuit (IC) on the Server Board. The new IC is identical in form factor and function to the previous one. As a result, we are adding as alternates the following PBA: M71671-951, M71671-961.
- Adding a second source for a Voltage Regulator (VR) controller on the Hot swap backplane (HSBP). The new controller is identical in function to the previous one but differs in form factor. The new components have passed all functional and electrical validation tests successfully. As a result, we are adding as alternate the following PBA: H88386-301.
- We are also adding as alternate the following PBA: H88386-311, which includes the second source for the Voltage Regulator (VR) controller and the interposer PCB supporting a new Programmable System-On-Chip (PSOC).

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2208WF0ZSR, Single	R2208WF0ZSR	986050	K39997-012	H87179-961, H87179-951, H88386-252, H88386-253	K39997-013	H87179-961, H87179-951, M71671-951, M71671-961, H88386-252, H88386-253, H88386-301, H88386-311

PCN Revision History:

Date of Revision:

March 11, 2022

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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